

SD Card Interface

User's Manual

Multimedia Processor for Mobile Applications
EMMA MobileTM EV2

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

How to Use This Manual

1. Purpose and Target Readers

This manual is designed to provide the user with an understanding of the hardware functions and electrical characteristics of the MCU. It is intended for users designing application systems incorporating the MCU. A basic knowledge of electric circuits, logical circuits, and MCUs is necessary in order to use this manual.

The manual comprises an overview of the product; descriptions of the CPU, system control functions, peripheral functions, and electrical characteristics; and usage notes.

Particular attention should be paid to the precautionary notes when using the manual. These notes occur within the body of the text, at the end of each section, and in the Usage Notes section.

The revision history summarizes the locations of revisions and additions. It does not list all revisions. Refer to the text of the manual for details.

The following documents apply to the EMMA Mobile EV2. Make sure to refer to the latest versions of these documents. The newest versions of the documents listed may be obtained from the Renesas Electronics Web site.

Document Type	Description	Document Title	Document No.
Data Sheet	Hardware overview and electrical characteristics	EMMA Mobile EV2 Datasheet	R19DS0010EJxxxx
User's manual (1chip)	Hardware whole specifications (pin assignments, memory maps, peripheral function specifications, electrical characteristics, timing charts) and operation description	EMMA Mobile EV2 User's manual 1chip	R19UH0036EJxxxx
User's manual (module)	Hardware each macro specifications and operation description.	EMMA Mobile EV2 User's manual each module	See below

Document Name	Document No.	Document Name	Document No.
1chip	R19UH0036EJxxxx	DMA Controller	R19UH0043EJxxxx
System Management Unit	R19UH0037EJxxxx	LP-DDR/DDR2 Controller	R19UH0039EJxxxx
Timer	R19UH0054EJxxxx	SD Memory Card Interface (This manual)	R19UH0061EJxxxx
System Timer	R19UH0055EJxxxx	SDIO Interface	R19UH0042EJxxxx
HD Video Decoder	R19UH0056EJxxxx	CF Card Interface	R19UH0062EJxxxx
Rotator	R19UH0057EJxxxx	Unified Serial Interface	R19UH0047EJxxxx
Resizer	R19UH0058EJxxxx	UART interface	R19UH0040EJxxxx
Image Composer	R19UH0038EJxxxx	USB 2.0 Host Controller	R19UH0045EJxxxx
LCD Interface	R19UH0044EJxxxx	USB 2.0 Function Controller	R19UH0034EJxxxx
ITU-R BT.656 Interface	R19UH0059EJxxxx	IIC Interface	R19UH0052EJxxxx
Digital Terrestrial TV Interface	R19UH0048EJxxxx	General Purpose I/O Interface	R19UH0041EJxxxx
Camera Interface	R19UH0060EJxxxx	Pulse Width Modulation Interface	R19UH0063EJxxxx

4 digits of end shows the version.

2. Notation of Numbers and Symbols

The notation conventions for register names, bit names, numbers, and symbols used in this manual are described below.

(1) Register Names, Bit Names, and Pin Names

Registers, bits, and pins are referred to in the text by symbols. The symbol is accompanied by the word “register,” “bit,” or “pin” to distinguish the three categories.

Examples the PM03 bit in the PM0 register
 P3_5 pin, VCC pin

(2) Notation of Numbers

The indication “b” is appended to numeric values given in binary format. However, nothing is appended to the values of single bits. The indication “h” is appended to numeric values given in hexadecimal format. Nothing is appended to numeric values given in decimal format.

Examples Binary: 11b or 11
 Hexadecimal: EFA0h
 Decimal: 1234

3. Register Notation

The symbols and terms used in register diagrams are described below.

x.x.x XXX register

This register (XXXXXXX: xxxx_xxxxh)

7	6	5	4	3	2	1	0
Reserved		CHG_P1_LA T	LATCH_P1_ SEL	Reserved		CHG_P0_LAT	CHG_P0_LAT_ SEL

Name	R/W	Bit No.	After Reset	Description
LATCH_P2_SEL	R/W	8	0	0: Use the P2_LAT bit of the P2_POWERSW register in the SMU to latch data. 1: Use the CHG_P2_LAT bit to latch data.
Reserved	R	7:6	–	Reserved. If these bits are read, 0 is returned for each bit.
CHG_P1_LAT	R/W	5	1	0: Output data as is. 1: Output latched data.
LATCH_P1_SEL	R/W	4	0	0: Use the P1_LAT bit of the P1_POWERSW register in the SMU to latch data. 1: Use the CHG_P1_LAT bit to latch data.
Reserved	R	3:2	–	Reserved. If these bits are read, 0 is returned for each bit.
CHG_P0_LAT	R/W	1	1	0: Output data as is. 1: Output latched data.
CHG_P0_LAT_SEL	R/W	0	0	0: Use the P0_LAT bit of the P2_POWERSW register in the SMU to latch data. 1: Use the CHG_P0_LAT bit to latch data.

*1

*3

*2

*1

R/W: Read and Write.

R: Read only.

W: Write only.

–: Nothing is assigned.

*2

Reserved bit.

Reserved bit. Set to specified value.

*3

- Nothing is assigned.

Nothing is assigned to the bit. As the bit may be used for future functions, if necessary, set to 0.

- Do not set to a value.

Operation is not guaranteed when a value is set.

- Function varies according to the operating mode.

The function of the bit varies with the peripheral function mode. Refer to the register diagram for information on the individual modes.

4. List of Abbreviations and Acronyms

Abbreviation	Full Form
ACIA	Asynchronous Communication Interface Adapter
bps	bits per second
CRC	Cyclic Redundancy Check
DMA	Direct Memory Access
DMAC	Direct Memory Access Controller
GSM	Global System for Mobile Communications
Hi-Z	High Impedance
IEBus	Inter Equipment Bus
I/O	Input/Output
IrDA	Infrared Data Association
LSB	Least Significant Bit
MSB	Most Significant Bit
NC	Non-Connect
PLL	Phase Locked Loop
PWM	Pulse Width Modulation
SFR	Special Function Register
SIM	Subscriber Identity Module
UART	Universal Asynchronous Receiver/Transmitter
VCO	Voltage Controlled Oscillator

Abbreviation	Full Form
AHB	Advanced High-performance Bus
CHG	Alternate Pin Function Switching Module
CPRM	Content Protection for Recordable Media
eMMC	Embedded Multi Media Card
GPIO	General Purpose I/O
IRQ	Interrupt Request
MMC	Multi Media Card
MP3	MPEG Audio Layer-3

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Table of Contents

1. Overview	1
1.1 Features	1
2. Pin Functions	2
3. Registers.....	3
3.1 Register List.....	3
3.2 Register Details.....	5
3.2.1 SD card command register	5
3.2.2 SD card port select register	6
3.2.3 SD card command parameter register 0	7
3.2.4 SD card command parameter register 1	7
3.2.5 SD card stop register	8
3.2.6 SD card transfer sector count register	8
3.2.7 SD card response register 0	9
3.2.8 SD card response register 1	9
3.2.9 SD card response register 2	10
3.2.10 SD card response register 3	10
3.2.11 SD card response register 4	11
3.2.12 SD card response register 5	11
3.2.13 SD card response register 6	12
3.2.14 SD card response register 7	12
3.2.15 SD card information register 1	13
3.2.16 SD card information register 2	14
3.2.17 SD card information mask register 1	16
3.2.18 SD card information mask register 2	17
3.2.19 SD card transfer clock control register.....	18
3.2.20 SD card transfer data size register.....	19
3.2.21 SD card option setting register	19
3.2.22 SD card error interrupt status register 1	21
3.2.23 SD card error interrupt status register 2	23
3.2.24 SD card data buffer 0 register.....	24
3.2.25 SDIO mode setting register	25
3.2.26 SDIO information register.....	26
3.2.27 SDIO information mask register	27
3.2.28 SDC software reset control register.....	28
3.2.29 SDC user register	29
3.2.30 SDC user register 2	30
3.2.31 Module reset control register.....	31
3.2.32 AHB bus interface control register.....	32
3.2.33 DMA mask setting register.....	33
3.2.34 SD write transfer data storage address	33
3.2.35 SD read transfer data storage address.....	34
3.2.36 SD sector length setting register.....	34
3.2.37 SD block length setting register	34
3.2.38 DMA startup register.....	35
3.2.39 Interrupt mask register	36
3.2.40 Interrupt factor RAW register	37
3.2.41 Interrupt factor register.....	38
3.2.42 Interrupt factor clear register.....	39

3.2.43	SD write transfer data storage address	39
3.2.44	SD read transfer data storage address.....	40
3.2.45	DMA mode SD buffer register	40
4.	Description of Functions	41
4.1	SD Card Data Format.....	41
4.2	SDIO Interrupts.....	42

SD Card Interface

R19UH0061EJ0500

Rev.5.00

EMMA Mobile EV2

Dec 21, 2011

1. Overview

This module (SDC) is an SD card interface that complies with SD card interface Physical Layer Version 2.00 and SD card interface Security Version 2.00. In addition to performing I/O with a card, this module can perform hardware-based CPRM authentication, and encrypt or decrypt data. The module can also be used as an SDIO card or MMC/eMMC (4.0 or equivalent) host controller. (CPRM is the option function.)

1.1 Features

The main features of the SDC module are as follows:

- Serial interface for SD cards and SDIO cards
- Supports a line width of 1 bit or 4 bits for transferring data to and from SD cards or SDIO cards.
- Supports data transfers in frame units.
- Supports CRC7 error checks on the command line and CRC16 checks (hardware) on each data bit line.
- Provides one SD card and SDIO card port.
- The data transfer buffer for SD cards is configured of two blocks of 16 bits × 256 words.
- Supports data transfers from 1 to 512 bytes.
- Two 256 word × 16 bit encryption circuit data transfer buffers, one for input and one for output
- Supports normal SD cards (transfer frequency: 25 MHz) and high-speed SD cards (transfer frequency: 50 MHz)
- The SD card transfer clock signal can be derived from the source clock signal in the SDC module (by selecting to divide the source clock frequency by 2, 4, 8, 16, ..., or 512).
- A source clock is internal system clock of a SDC (SDC_CLK : A normal mode operate by 133MHz.) . The maximum clock frequency which can be used as SD transfer clock by a normal mode of EMEV is 33.25MHz.
 - When SDCCLK is 133MHz (the CPU:532MHz system) : up to 33.25MHz.
 - When SDCCLK is 100MHz (the CPU:400MHz system) : up to 50.00MHz.
 - At most 50 MHz is covered as a SDC module.
- Supports hardware-based mutual authentication and provides a hardware implementation of an encryption algorithm using a C2 core.
- Provides a master key for performing device key encryption and decryption.
- Turns off the clock in the standby mode (when no SD card is inserted).
- Provides hardware-based CPRM.
- Supports SD Binding and SDS (secure digital separate delivery).
- Performs hardware-based analysis of sound format headers such as MP3.
- Supports SDIP version 2.8.

2. Pin Functions

Pin Name	I/O	Function	Alternate Pin Function
SD_CKO	Output	SD card clock output	–
SD_CKI	Input	SD card clock input	GPIO_048
SD_CMD	I/O	SD card command	–
SD_DATA3	I/O	SD card data bit 3	–
SD_DATA2	I/O	SD card data bit 2	–
SD_DATA1	I/O	SD card data bit 1	–
SD_DATA0	I/O	SD card data bit 0	–

3. Registers

3.1 Register List

The SDC registers can only be accessed by way of the AHB slave devices, and only in 32-bit units.

If register access in 16-bit or 8-bit units is attempted, it is handled as 32-bit access.

Base address: E210_0000H

(1/2)

Address	Register Name	Register Symbol	R/W	Reset
0000H	SD card command register	SDC_CMD	R/W	0000_0000H
0004H	SD card port select register	SDC_PORT	R/W	0000_0100H
0008H	SD card command parameter register 0	SDC_ARG0	R/W	0000_0000H
000CH	SD card command parameter register 1	SDC_ARG1	R/W	0000_0000H
0010H	SD card stop register	SDC_STOP	R/W	0000_0000H
0014H	SD card transfer sector count register	SDC_SECCNT	R/W	0000_0000H
0018H	SD card response register 0	SDC_RSP0	R	0000_0000H
001CH	SD card response register 1	SDC_RSP1	R	0000_0000H
0020H	SD card response register 2	SDC_RSP2	R	0000_0000H
0024H	SD card response register 3	SDC_RSP3	R	0000_0000H
0028H	SD card response register 4	SDC_RSP4	R	0000_0000H
002CH	SD card response register 5	SDC_RSP5	R	0000_0000H
0030H	SD card response register 6	SDC_RSP6	R	0000_0000H
0034H	SD card response register 7	SDC_RSP7	R	0000_0000H
0038H	SD card information register 1	SDC_INFO1	R/W, R	Undefined (0000_068DH)
003CH	SD card information register 2	SDC_INFO2	R/W, R	Undefined (0000_2080H)
0040H	SD card information mask register 1	SDC_INFO1_MASK	R/W	0000_031DH
0044H	SD card information mask register 2	SDC_INFO2_MASK	R/W	0000_8B7FH
0048H	SD card transfer clock control register	SDC_CLK_CTRL	R/W	0000_0020H
004CH	SD card transfer data size register	SDC_SIZE	R/W	0000_0200H
0050H	SD card option setting register	SDC_OPTION	R/W	0000_00EEH
0054H	Reserved	—	—	—
0058H	SD card error interrupt status register 1	SDC_ERR_STS1	R	0000_2000H
005CH	SD card error interrupt status register 2	SDC_ERR_STS2	R	0000_0000H
0060H	SD card data buffer 0 register	SDC_BUF0	R/W	Undefined
0064H	Reserved	—	—	—
0068H	SDIO mode setting register	SDC_SDIO_MODE	R/W	0000_0000H
006CH	SDIO information register	SDC_SDIO_INFO1	R/W	0000_0000H
0070H	SDIO information mask register	SDC_SDIO_INFO1_MASK	R/W	0000_C007H
0074H to 01BCH	Reserved	—	—	—

(2/2)

Address	Register Name	Register Symbol	R/W	Reset
01C0H	SDC software reset control register	SDC_SOFT_RST	R/W	0000_0000H
01C4H to 01E0H	Reserved	—	—	—
0200H	SDC user register	SDC_USER	R/W, R	0000_0004H
0204H	SDC user register 2	SDC_USER2	R/W	0000_0000H
0208H to 020CH	Reserved	—	—	—
0210H	Module reset control register	SDC_RST_CTRL	R/W	0000_0000H
0214H	AHB bus interface control register	SDC_BUSIF_CTRL	R/W, R	0000_0000H
0218H	Reserved	—	—	—
021CH	DMA mask setting register	SDC_DMASK_CTRL	R/W	0000_000FH
0220H	SD write transfer data storage address	SDC_TXMEM_ADDR0L	R/W	0000_0000H
0224H	Reserved	—	—	—
0228H	SD read transfer data storage address	SDC_RXMEM_ADDR0L	R/W	0000_0000H
022CH	Reserved	—	—	—
0230H	SD sector length setting register	SDC_SECTOR_LENGTH0	R/W	0000_0000H
0234H to 023CH	Reserved	—	—	—
0240H	SD block length setting register	SDC_BLOCK_LENGTH0	R/W	0000_0000H
0244H to 025CH	Reserved	—	—	—
0260H	DMA startup register	SDC_TRANS_START	R/W	0000_0000H
0264H to 026CH	Reserved	—	—	—
0270H	Interrupt mask register	SDC_INT_MSK	R/W	0000_000FH
0274H	Interrupt factor RAW register	SDC_INT_RAW	R/W	0000_000FH
0278H	Interrupt factor register	SDC_INT_ORG	R/W	0000_000FH
027CH	Interrupt factor clear register	SDC_INT_CLR	R/W	0000_000FH
0274H to 028CH	Reserved	—	—	—
0290H	SD write transfer data storage address	SDC_TXMEM_ADDR0H	R/W	0000_0000H
0294H	Reserved	—	—	—
0298H	SD read transfer data storage address	SDC_RXMEM_ADDR0H	R/W	0000_0000H
0300H	DMA mode SD buffer register	SDC_DMASD	R/W	0000_0000H

3.2 Register Details

3.2.1 SD card command register

This register (SDC_CMD: 0000H) controls the SD card commands and responses.

15	14	13	12	11	10	9	8
MD7	MD6	MD5	MD4	MD3	MD2	MD1	MD0

7	6	5	4	3	2	1	0
C1	C0	CF45	CF44	CF43	CF42	CF41	CF40

(1/2)

Name	R/W	Bit No.	After Reset	Description																		
MD[7:6]	R/W	15:14	00b	Specify the CMD12 mode. 00: Automatic CMD12 transfer 01: Non-automatic CMD12 transfer (SDIO command) (transfer between host and SD card) 10: Reserved 11: Reserved Remark Automatic CMD12 transfer means that CMD12 is automatically transferred according to the sector count, after which data transfer stops.																		
MD5	R/W	13	0	Select the transfer type. 0: Single-block transfer 1: Multiple-block transfer																		
MD4	R/W	12	0	Specify the write or read mode. 0: Write 1: Read																		
MD3	R/W	11	0	Specify the data mode. 0: No data 1: Data is present																		
MD[2:0]	R/W	10:8	000b	Specify an expansion command and the response type. <table><thead><tr><th>Command mode</th><th>Response type</th></tr></thead><tbody><tr><td>000: Normal mode</td><td>SD cards and multimedia cards decoding command</td></tr><tr><td>001: Expansion command</td><td>Reserved</td></tr><tr><td>010: Expansion command</td><td>Reserved</td></tr><tr><td>011: Expansion command</td><td>No response</td></tr><tr><td>100: Expansion command</td><td>R1, R6, R5</td></tr><tr><td>101: Expansion command</td><td>R1b, R5b</td></tr><tr><td>110: Expansion command</td><td>R2</td></tr><tr><td>111: Expansion command</td><td>R3, R4</td></tr></tbody></table>	Command mode	Response type	000: Normal mode	SD cards and multimedia cards decoding command	001: Expansion command	Reserved	010: Expansion command	Reserved	011: Expansion command	No response	100: Expansion command	R1, R6, R5	101: Expansion command	R1b, R5b	110: Expansion command	R2	111: Expansion command	R3, R4
Command mode	Response type																					
000: Normal mode	SD cards and multimedia cards decoding command																					
001: Expansion command	Reserved																					
010: Expansion command	Reserved																					
011: Expansion command	No response																					
100: Expansion command	R1, R6, R5																					
101: Expansion command	R1b, R5b																					
110: Expansion command	R2																					
111: Expansion command	R3, R4																					

(2/2)

Name	R/W	Bit No.	After Reset	Description
C[1:0]	R/W	7:6	00b	Specify the command mode. 00: SD card or multimedia card command 01: ACMD following CMD55 of an SD card 10: Mutual recognition command 11: Reserved
CF[45:40]	R/W	5:0	00H	Specify the command index specified for bits 45 to 40 in the SD card command format. 0: CF40 1: CF41 2: CF42 3: CF43 4: CF44 5: CF45

Remark For details about setup commands and responses, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.2 SD card port select register

This register (SDC_PORT: 0004H) specifies the port used when multiple SD card ports are mounted.

15	14	13	12	11	10	9	8
Reserved					NP2	NP1	NP0
7	6	5	4	3	2	1	0
Reserved						P1	P0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:11	–	Reserved. If these bits are read, 0 is returned for each bit.
NP[2:0]	R	10:8	001b	Specify the number of supported SD cards. 000: Setting prohibited 001: 1 port (default) 010: Setting prohibited 011: Setting prohibited 100: Setting prohibited
Reserved	R	7:2	–	Reserved. If these bits are read, 0 is returned for each bit.
P[1:0]	R/W	1:0	00b	Select the port number of the selected SD card. 00: Port 0 01: Setting prohibited ^{Note} 10: Setting prohibited ^{Note} 11: Setting prohibited ^{Note}

Note Operation is not guaranteed if a value other than 0 is specified for bits P1 and P0.

3.2.3 SD card command parameter register 0

This register (SDC_ARG0: 0008H) stores the SD card command parameters.

15	14	13	12	11	10	9	8
CF23	CF22	CF21	CF20	CF19	CF18	CF17	CF16

7	6	5	4	3	2	1	0
CF15	CF14	CF13	CF12	CF11	CF10	CF9	CF8

Name	R/W	Bit No.	After Reset	Description
CF[23:8]	R/W	15:0	0000H	Specify the parameters for the command to be transferred to the SD card. The settings of these bits correspond to bits 23 to 8 of the command format.

Remark For details about setup commands and responses, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.4 SD card command parameter register 1

This register (SDC_ARG1: 000CH) stores the SD card command parameters.

15	14	13	12	11	10	9	8
CF39	CF38	CF37	CF36	CF35	CF34	CF33	CF32

7	6	5	4	3	2	1	0
CF31	CF30	CF29	CF28	CF27	CF26	CF25	CF24

Name	R/W	Bit No.	After Reset	Description
CF[39:24]	R/W	15:0	0000H	Specify the parameters for the command to be transferred to the SD card. The settings of these bits correspond to bits 39 to 24 of the command format.

Remark For details about setup commands and responses, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.5 SD card stop register

This register (SDC_STOP: 0010H) specifies stopping SD transfers.

15	14	13	12	11	10	9	8
Reserved							SEC
7	6	5	4	3	2	1	0
Reserved							STP

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:9	00H	Reserved. If these bits are read, 0 is returned for each bit.
SEC	R/W	8	0	Specify whether to enable or disable the SDC_SECCNT register. 0: Disable 1: Enable
Reserved	R	7:1	00H	Reserved. If these bits are read, 0 is returned for each bit.
STP	R/W	0	0	Transfer stop bit 0: Do not stop transfer. Clear this bit to 0 before CMD17, CMD18, CMD24, CMD27, CMD30, CMD42, CMD56, CMD43 to CMD48, ACMD18, or ACMD25 is set. 1: Stop transfer.

3.2.6 SD card transfer sector count register

This register (SDC_SECCNT: 0014H) counts the number of transfer sectors.

15	14	13	12	11	10	9	8
CNT15	CNT14	CNT13	CNT12	CNT11	CNT10	CNT9	CNT8
7	6	5	4	3	2	1	0
CNT7	CNT6	CNT5	CNT4	CNT3	CNT2	CNT1	CNT0

Name	R/W	Bit No.	After Reset	Description
CNT[15:0]	R/W	15:0	0000H	16-bit counter that counts the number of transfer sectors

Remark If the SDC_SECCNT register is 0001H, the number of transfer sectors is 1.
 If the SDC_SECCNT register is FFFFH, the number of transfer sectors is 65,535.
 If the SDC_SECCNT register is 0000H, the number of transfer sectors is 65,536.

3.2.7 SD card response register 0

This register (SDC_RSP0: 0018H) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R23	R22	R21	R20	R19	R18	R17	R16

7	6	5	4	3	2	1	0
R15	R14	R13	R12	R11	R10	R9	R8

Name	R/W	Bit No.	After Reset	Description
R[23:8]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 23 to 8 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.8 SD card response register 1

This register (SDC_RSP1: 001CH) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R39	R38	R37	R36	R35	R34	R33	R32

7	6	5	4	3	2	1	0
R31	R30	R29	R28	R27	R26	R25	R24

Name	R/W	Bit No.	After Reset	Description
R[39:24]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 39 to 24 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.9 SD card response register 2

This register (SDC_RSP2: 0020H) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R55	R54	R53	R52	R51	R50	R49	R48
7	6	5	4	3	2	1	0
R47	R46	R45	R44	R43	R42	R41	R40

Name	R/W	Bit No.	After Reset	Description
R[55:40]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 55 to 40 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.10 SD card response register 3

This register (SDC_RSP3: 0024H) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R71	R70	R69	R68	R67	R66	R65	R64
7	6	5	4	3	2	1	0
R63	R62	R61	R60	R59	R58	R57	R56

Name	R/W	Bit No.	After Reset	Description
R[71:56]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 71 to 56 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.11 SD card response register 4

This register (SDC_RSP4: 0028H) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R87	R86	R85	R84	R83	R82	R81	R80

7	6	5	4	3	2	1	0
R79	R78	R77	R76	R75	R74	R73	R72

Name	R/W	Bit No.	After Reset	Description
R[87:72]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 87 to 72 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.12 SD card response register 5

This register (SDC_RSP5: 002CH) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R103	R102	R101	R100	R99	R98	R97	R96

7	6	5	4	3	2	1	0
R95	R94	R93	R92	R91	R90	R89	R88

Name	R/W	Bit No.	After Reset	Description
R[103:88]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 103 to 88 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.13 SD card response register 6

This register (SDC_RSP6: 0030H) stores the responses returned from the SD card.

15	14	13	12	11	10	9	8
R119	R118	R117	R116	R115	R114	R113	R112
7	6	5	4	3	2	1	0
R111	R110	R109	R108	R107	R106	R105	R104

Name	R/W	Bit No.	After Reset	Description
R[119:104]	R	15:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 119 to 104 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.14 SD card response register 7

This register (SDC_RSP7: 0034H) stores the responses returned from the SD card.

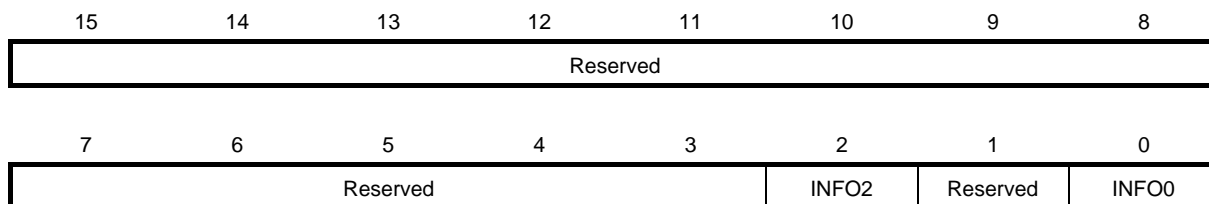
15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
R127	R126	R125	R124	R123	R122	R121	R120

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:8	0	Reserved. If these bits are read, 0 is returned for each bit.
R[127:120]	R	7:0	0000H	Store the responses returned from the SD card. The settings of these bits correspond to bits 127 to 120 of the response format.

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

3.2.15 SD card information register 1

This register (SDC_INFO1: 0038H) indicates the status of the SDC interrupt sources.



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:3	000H	Reserved. If these bits are read, 0 is returned for each bit.
INFO2	R/W	2	0	Indicates whether the read/write access has finished. 0: Not finished 1: Finished
Reserved	R	1	0	Reserved. If this bit is read, 0 is returned.
INFO0	R/W	0	0	Indicates whether the response has finished. 0: Not finished 1: Finished

3.2.16 SD card information register 2

This register (SDC_INFO2: 003CH) indicates the error and buffer status interrupt sources of the SDC module.

15	14	13	12	11	10	9	8
ILA	CBSY	SCLKDIVEN	Reserved			BWE	BRE
7	6	5	4	3	2	1	0
DAT0	ERR6	ERR5	ERR4	ERR3	ERR2	ERR1	ERR0

(1/2)

Name	R/W	Bit No.	After Reset	Description
ILA	R/W	15	0	Illegal access error ^{Note 1} 0: Normal access 1: Illegal access error
CBSY	R	14	0	Command register busy 0: Transfer is complete. 1: Transfer is in progress.
SCLKDIVEN	R	13	0	Indicates whether the SD bus is busy transmitting commands and data. 0: Busy 1: Not busy
Reserved	R	12:10	0H	Reserved. If these bits are read, 0 is returned for each bit.
BWE	R/W	9	0	Specify whether to enable writing to the SD card. 0: Disable 1: Enable (The SDC data buffer is empty.)
BRE	R/W	8	0	Specify whether to enable reading from the SD card. 0: Disable 1: Enable (The SDC data buffer is full.)
DAT0	R	7	Undefined	Indicates the status of SD data line 0. 0: SD_DATA0 = 0 1: SD_DATA0 = 1
ERR6	R/W	6	0	Response timeout 0: No response timeout error occurred. 1: A response timeout error occurred (because no command response or SD_STOP response was issued for 64 SD clock cycles or more).
ERR5	R/W	5	0	Invalid data buffer read error bit 0: No invalid data buffer read error occurred. 1: An invalid data buffer read error occurred (because an attempt was made to read data from the data buffer even though the data buffer was empty).

(2/2)

Name	R/W	Bit No.	After Reset	Description
ERR4	R/W	4	0	Invalid data buffer write error bit 0: No invalid data buffer write error occurred. 1: An invalid data buffer write error occurred ^{Note 2} .
ERR3	R/W	3	0	Timeout (other than a response) error 0: No timeout error occurred. 1: A timeout error occurred ^{Note 3} .
ERR2	R/W	2	0	End error status bit 0: No end error occurred. 1: An end error occurred ^{Note 4} .
ERR1	R/W	1	0	CRC error status bit 0: No CRC error occurred. 1: A CRC error occurred ^{Note 5} .
ERR0	R/W	0	0	Command error status bit 0: No command error occurred. 1: A command error occurred ^{Note 6} .

Remark For details about the response formats, see *SD Specifications Part 1 Physical Layer Simplified Specification Ver. 2.0*.

Note 1. This error occurs in any of the following cases:

- If the command register is rewritten during a transfer.
- If *no response* (MD[2:0] = 011) and *data is present* (MD3 = 1) is specified for the SDC_CMD register.
- If CMD12 for which data is present is specified for the SDC_CMD register.

2. This error occurs in any of the following cases:

- If data is written to data buffer SDC_BUF0 when the data read or data write command status is not asserted.
- If data is written before SDC_BUF0 becomes empty during a single block write.
- If data is written to bank 1 of the data buffer before the bank becomes empty during a multiple block write.

3. This error occurs in any of the following five cases:

- If SDDAT0 is 0 (busy) for a longer period of time than the number of cycles specified by bits 7 to 4 of the SDC_OPTION register after an R1b response is received.
- If SDDAT0 is 0 (busy) for a longer period of time than the number of cycles specified by bits 7 to 4 of the SDC_OPTION register after the CRC status is written.
- If the CRC status is not written for a longer period of time than the number of cycles specified by bits 7 to 4 of the SDC_OPTION register after a write access.
- If SDDAT0 is 0 (busy) for a longer period of time than the number of cycles specified by bits 7 to 4 of the SDC_OPTION register after a read command is issued.
- If SDDAT0 is 0 (busy) for a longer period of time than the number of cycles specified by bits 7 to 4 of the SDC_OPTION register after an SD_STOP response is issued.

4. *End error* refers to an END bit error in a command response (response length), in the data read (data length), when the CRC status is written (CRC status length), or in an SD_STOP response.

5. *CRC error* refers to a CRC status write error, a CRC16 error in the data read, a CRC7 error in a stop response, or a CRC7 error in a response.

6. *Command error* refers to a command index error in a command response or in an SD_STOP response.

3.2.17 SD card information mask register 1

This register (SDC_INFO1_MASK: 0040H) disables the SDC interrupt sources shown in the SDC_INFO1 register.

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved					IMASK2	Reserved	IMASK0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:3	000H	Reserved. If these bits are read, 0 is returned for each bit.
IMASK2	R/W	2	1	Specify whether to disable the interrupt issued when the end of a read/write access is detected. 0: Enable 1: Disable
Reserved	R	1	0	Reserved. If this bit is read, 0 is returned.
IMASK0	R/W	0	1	Specify whether to disable the interrupt issued when the end of a response is detected. 0: Enable 1: Disable

3.2.18 SD card information mask register 2

This register (SDC_INFO2_MASK: 0044H) disables the SDC interrupt sources shown in the SDC_INFO2 register.

15	14	13	12	11	10	9	8
IMASK	Reserved					BMSK1	BMSK0
7	6	5	4	3	2	1	0
Reserved	EMASK6	EMASK5	EMASK4	EMASK3	EMASK2	EMASK1	EMASK0

Name	R/W	Bit No.	After Reset	Description
IMASK	R/W	15	1	Specify whether to disable the illegal access interrupt. 0: Enable 1: Disable
Reserved	R	14:10	00H	Reserved. If these bits are read, 0 is returned for each bit.
BMSK1	R/W	9	1	Specify whether to disable the write enable interrupt. 0: Enable 1: Disable
BMSK0	R/W	8	1	Specify whether to disable the read enable interrupt. 0: Enable 1: Disable
Reserved	R	7	0	Reserved. If this bit is read, 0 is returned.
EMASK6	R/W	6	1	Specify whether to disable the response timeout interrupt. 0: Enable 1: Disable
EMASK5	R/W	5	1	Specify whether to disable the illegal data buffer read access interrupt. 0: Enable 1: Disable
EMASK4	R/W	4	1	Specify whether to disable the illegal data buffer write access interrupt. 0: Enable 1: Disable
EMASK3	R/W	3	1	Specify whether to disable the timeout (other than response) interrupt. 0: Enable 1: Disable
EMASK2	R/W	2	1	Specify whether to disable the end error interrupt. 0: Enable 1: Disable
EMASK1	R/W	1	1	Specify whether to disable the CRC error interrupt. 0: Enable 1: Disable
EMASK0	R/W	0	1	Specify whether to disable the command error interrupt. 0: Enable 1: Disable

3.2.19 SD card transfer clock control register

This register (SDC_CLK_CTRL: 0048H) specifies the ratio for dividing the SD card transfer clock frequency.

15	14	13	12	11	10	9	8
Reserved					SDCLKSEL	SDCLKOFFEN	SCLKEN
7	6	5	4	3	2	1	0
DIV7	DIV6	DIV5	DIV4	DIV3	DIV2	DIV1	DIV0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:11	00H	Reserved. If these bits are read, 0 is returned for each bit.
SDCLKSEL	R/W	10	0	Select the type of SD card according to the transfer clock speed. 0: Normal SD card 1: High-speed SD card
SDCLKOFFEN	R/W	9	0	Specify whether to enable turning on and off the SD card transfer clock signal (SDCLK). 0: Disable 1: Enable (The clock signal can be turned off when no transfers are being executed).
SCLKEN	R/W	8	0	Specify whether to enable the SDCLK signal. 0: Disable (low output) 1: Enable
DIV[7:0]	R/W	7:0	20H	Specify the ratio for dividing the frequency of the SDCLK signal created from SDC_CLK. 0: Division by 2 1: Division by 4 2: Division by 8 4: Division by 16 8: Division by 32 16: Division by 64 32: Division by 128 64: Division by 256 128: Division by 512 Caution The SDCLK signal stops if a value other the above is specified.

3.2.20 SD card transfer data size register

This register (SDC_SIZE: 004CH) specifies the transfer data size.

15	14	13	12	11	10	9	8
Reserved						LEN9	LEN8
7	6	5	4	3	2	1	0
LEN7	LEN6	LEN5	LEN4	LEN3	LEN2	LEN1	LEN0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:10	000H	Reserved. If these bits are read, 0 is returned for each bit.
LEN[9:0]	R/W	9:0	200H	Specify the size of the SD data to be transferred. 1 to 512 bytes can be specified in byte units. Do not set this field to 0. Do not specify 513 or more bytes.

3.2.21 SD card option setting register

This register (SDC_OPTION: 0050H) specifies various options.

15	14	13	12	11	10	9	8
WIDTH	Reserved						
7	6	5	4	3	2	1	0
TOP27	TOP26	TOP25	TOP24	CTOP24	CTOP23	CTOP22	CTOP21

Name	R/W	Bit No.	After Reset	Description
WIDTH	R/W	15	0	Specify the SD data transfer bit width. 0: 4 bits 1: 1 bit
Reserved	R	14:8	00H	Reserved. If these bits are read, 0 is returned for each bit.
TOP[27:24]	R/W	7:4	EH	Response timeout counter
CTOP[24:21]	R/W	3:0	EH	Card detection stabilization time counter

TOP[27:24] Response timeout counter

TOP27	TOP26	TOP25	TOP24	Description
1	1	1	1	Timeout testing mode
1	1	1	0	SD transfer clock $\times 2^{27}$
1	1	0	1	SD transfer clock $\times 2^{26}$
1	1	0	0	SD transfer clock $\times 2^{25}$
1	0	1	1	SD transfer clock $\times 2^{24}$
1	0	1	0	SD transfer clock $\times 2^{23}$
1	0	0	1	SD transfer clock $\times 2^{22}$
1	0	0	0	SD transfer clock $\times 2^{21}$
0	1	1	1	SD transfer clock $\times 2^{20}$
0	1	1	0	SD transfer clock $\times 2^{19}$
0	1	0	1	SD transfer clock $\times 2^{18}$
0	1	0	0	SD transfer clock $\times 2^{17}$
0	0	1	1	SD transfer clock $\times 2^{16}$
0	0	1	0	SD transfer clock $\times 2^{15}$
0	0	0	1	SD transfer clock $\times 2^{14}$
0	0	0	0	SD transfer clock $\times 2^{13}$

CTOP[24:21] Card detection stabilization time counter

CTOP24	CTOP23	CTOP22	CTOP21	Description
1	1	1	1	Timeout testing mode
1	1	1	0	SD transfer clock $\times 2^{27}$
1	1	0	1	SD transfer clock $\times 2^{26}$
1	1	0	0	SD transfer clock $\times 2^{25}$
1	0	1	1	SD transfer clock $\times 2^{24}$
1	0	1	0	SD transfer clock $\times 2^{23}$
1	0	0	1	SD transfer clock $\times 2^{22}$
1	0	0	0	SD transfer clock $\times 2^{21}$
0	1	1	1	SD transfer clock $\times 2^{20}$
0	1	1	0	SD transfer clock $\times 2^{19}$
0	1	0	1	SD transfer clock $\times 2^{18}$
0	1	0	0	SD transfer clock $\times 2^{17}$
0	0	1	1	SD transfer clock $\times 2^{16}$
0	0	1	0	SD transfer clock $\times 2^{15}$
0	0	0	1	SD transfer clock $\times 2^{14}$
0	0	0	0	SD transfer clock $\times 2^{13}$

3.2.22 SD card error interrupt status register 1

This register (SDC_ERR_STS1: 0058H) indicates the status of the interrupts that are generated by an SDC error.

15	14	13	12	11	10	9	8
Reserved	E14	E13	E12	E11	E10	E9	E8
7	6	5	4	3	2	1	0
Reserved	E5	E4	E3	E2	E1	E0	

(1/2)

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15	0	Reserved. If this bit is read, 0 is returned.
E[14:12]	R	14:12	010b	Stores the CRC status in data sent from the SD card.
E11	R	11	0	Indicates whether a CRC write error occurred. 0: Did not occur 1: Occurred
E10	R	10	0	Indicates whether a CRC error occurred in read data. 0: Did not occur 1: Occurred
E9	R	9	0	Indicates whether a CRC error occurred in an SD_STOP response. 0: Did not occur 1: Occurred
E8	R	8	0	Indicates whether a CRC error occurred in a command response. 0: Did not occur 1: Occurred
Reserved	R	7:6	0H	Reserved. If these bits are read, 0 is returned for each bit.
E5	R	5	0	Indicates whether an end bit error occurred during CRC status writing. 0: Did not occur 1: Occurred
E4	R	4	0	Indicates whether an end bit error occurred in read data. 0: Did not occur 1: Occurred
E3	R	3	0	Indicates whether an end bit error occurred in an SD_STOP response. 0: Did not occur 1: Occurred
E2	R	2	0	Indicates whether an end bit error occurred in a command response. 0: Did not occur 1: Occurred

(2/2)

Name	R/W	Bit No.	After Reset	Description
E1	R	1	0	Indicates whether a command index error occurred in an SD_STOP response. 0: Did not occur 1: Occurred
E0	R	0	0	Indicates whether a command index error occurred in a command response. 0: Did not occur 1: Occurred

3.2.23 SD card error interrupt status register 2

This register (SDC_ERR_STS2: 005CH) indicates the status of the interrupts that are generated by an SDC error.

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved	E6	E5	E4	E3	E2	E1	E0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:7	00H	Reserved. If these bits are read, 0 is returned for each bit.
E6	R	6	0	0: No error has occurred. 1: An error has occurred (because the busy status continued for a period of time longer than the number of cycles specified for SDC_OPTION[7:4], after the CRC status was written).
E5	R	5	0	0: No error has occurred. 1: An error has occurred (because the CRC write status was not returned for a period of time longer than the number of cycles specified for SDC_OPTION[7:4] after a write access).
E4	R	4	0	0: No error has occurred. 1: An error has occurred (because the read data was not returned for a period of time longer than the number of cycles specified for SDC_OPTION[7:4] after the read command was issued).
E3	R	3	0	0: No error has occurred. 1: An error has occurred (because the status continued for a period of time longer than the number of cycles specified for SDC_OPTION[7:4] after a SD_STOP response was returned).
E2	R	2	0	0: No error has occurred. 1: An error has occurred (because the busy status continued for a period of time longer than the number of cycles specified for SDC_OPTION[7:4], after an R1b response was returned).
E1	R	1	0	0: No error has occurred. 1: An error has occurred (because no SD_STOP response was returned for 640 SD transfer clock cycles or more).
E0	R	0	0	0: No error has occurred. 1: An error has occurred (because no command response was returned for 640 SD transfer clock cycles or more).

3.2.24 SD card data buffer 0 register

This buffer register (SDC_BUF0: 0060H) stores the data read from and written to the SD card in the SDC module.

15	14	13	12	11	10	9	8
BUF15	BUF14	BUF13	BUF12	BUF11	BUF10	BUF9	BUF8

7	6	5	4	3	2	1	0
BUF7	BUF6	BUF5	BUF4	BUF3	BUF2	BUF1	BUF0

Name	R/W	Bit No.	After Reset	Description
BUF[15:0]	R/W	15:0	Undefined	Register for inputting and outputting data to and from the 512-byte × 2-bank data buffer

3.2.25 SDIO mode setting register

This register (SDC_SDIO_MODE: 0068H) controls selection of the SDIO mode.

15	14	13	12	11	10	9	8
Reserved						C52PUB	IOABT
7	6	5	4	3	2	1	0
Reserved					RWREQ	Reserved	IOMOD

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:10	00H	Reserved. If these bits are read, 0 is returned for each bit.
C52PUB	R/W	9	0	SD IO abortion (Data being transferred is guaranteed.) 0: Default 1: CMD52 is sent and the SD host holds IP transmission pending. The value before setting this bit is used as the CMD52 parameter. This bit is cleared after a CMD52 response is issued.
IOABT	R/W	8	0	SD IO abortion (Data being transferred is lost.) This bit must be specified only during multiple IO transactions. 0: Default 1: CMD52 is sent and the SD host stops IP transmission. The value before setting this bit is used as the CMD52 parameter.
Reserved	R	7:3	0H	Reserved. If these bits are read, 0 is returned for each bit.
RWREQ	R/W	2	0	Read wait request signal used during a multiple block read
Reserved	R/W	1	0	Reserved. If this bit is read, 0 is returned.
IOMOD	R/W	0	0	Specify whether to enable acknowledgment of interrupts from the SDIO card 0: Disable 1: Enable

3.2.26 SDIO information register

This register (SDC_SDIO_INFO1: 006CH) indicates the status of interrupt sources when the SDC module is used in SDIO mode.

15	14	13	12	11	10	9	8
EXWT	EXPUB52	Reserved					
7	6	5	4	3	2	1	0
Reserved					RWRDY	C52RDY	IOIRQ

Name	R/W	Bit No.	After Reset	Description
EXWT	R/W	15	0	Software read/write request 0: No request was issued. 1: A request was issued.
EXPUB52	R/W	14	0	Software read/write source 0: Data was written 1: C52PUB was set to 1 other than when a read or write transfer was performed
Reserved	R	13:3	000H	Reserved. If these bits are read, 0 is returned for each bit.
RWRDY	R/W	2	0	Indicates the read wait mode ready status. 0: Not ready 1: Ready
C52RDY	R/W	1	0	Indicates the CMD52 ready status. 0: Not ready to be issued. 1: Ready to be issued.
IOIRQ	R/W	0	0	Indicates the SDIO interrupt status. 0: No interrupt was issued from the SDIO card. 1: An interrupt was issued from the SDIO card.

3.2.27 SDIO information mask register

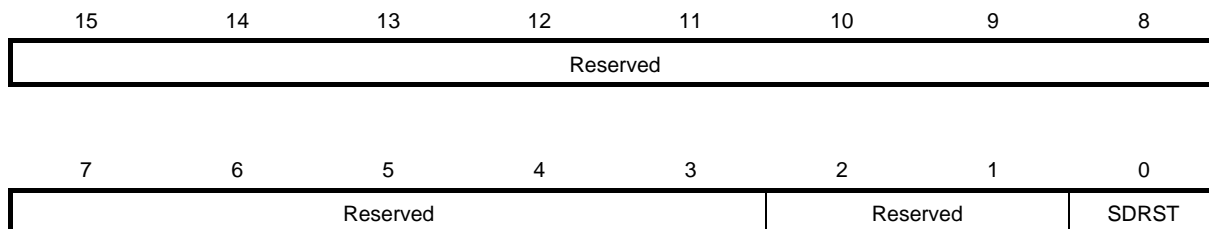
This register (SDC_SDIO_INFO1_MASK: 0070H) disables the interrupt sources assigned to the corresponding bits in SDIO mode.

15	14	13	12	11	10	9	8
EXWT_MASK	EXPUB52_MASK	Reserved					
7	6	5	4	3	2	1	0
Reserved					RWRDY_MASK	C52RDY_MASK	IOIRQ_MASK

Name	R/W	Bit No.	After Reset	Description
EXWT_MASK	R/W	15	1	Specify whether to disable the software read/write request. 0: Enable 1: Disable
EXPUB52_MASK	R/W	14	1	Specify whether to disable the software read/write request. 0: Enable 1: Disable
Reserved	R	13:3	000H	Reserved. If these bits are read, 0 is returned for each bit.
RWRDY_MASK	R/W	2	1	Specify whether to disable the read wait mode ready source. 0: Enable 1: Disable
C52RDY_MASK	R/W	1	1	Specify whether to disable the CMD52 ready source. 0: Enable 1: Disable
IOIRQ_MASK	R/W	0	1	Specify whether to disable the SDIO interrupt status source. 0: Enable 1: Disable

3.2.28 SDC software reset control register

This register (SDC_SOFT_RST: 01C0H) is used to execute a software reset for the SDC blocks.



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:3	0000H	Reserved. If these bits are read, 0 is returned for each bit.
Reserved	R	2:1	01b	Reserved. If these bits are read, 1 is returned for each bit.
SDRST	R/W	0	1	Control resetting the SD card interface block. 0: Reset the SDC module. 1: Cancel the reset state.

Caution Be sure to set bits 2 and 1 to 1.

3.2.29 SDC user register

This register (SDC_USER: 0200H) controls the SDC wrapper block.

15	14	13	12	11	10	9	8
SYNC	DMASDI	DMASDO	Reserved				SDCLKSTP
7	6	5	4	3	2	1	0
CLKSTP	Reserved		DMARQSEL2	DMARQSEL1	DMARQSEL0	Reserved	CD

(1/2)

Name	R/W	Bit No.	After Reset	Description
SYNC	R/W	15	0	Specify AB1 synchronous or asynchronous mode. 0: AB1 synchronous mode 1: AB1 asynchronous mode
DMASDI	R	14	0	Indicates whether there are DMA requests for reading the SD read buffer. 0: No request was issued. 1: A request was issued.
DMASDO	R	13	0	Indicates whether there are DMA requests for reading the SD write buffer. 0: No request was issued. 1: A request was issued.
Reserved	R	12:9	0H	Reserved. If these bits are read, 0 is returned for each bit.
SDCLKSTP	R/W	8	0	Select the SDCLK loop path. 0: External loop (SD_CKO → SD_CKI) ^{Note} 1: Setting prohibited
CLKSTP	R/W	7	0	Specify whether to oscillate or stop the SDC main module clock signal IMCLK. 0: Oscillate IMCLK. 1: Stop IMCLK.
Reserved	R	6:5	0H	Reserved. If these bits are read, 0 is returned for each bit.
DMARQSEL[2:0]	R/W	4:2	1H	Select the DMA request signal trigger. 100: SDC_RXDMARQ: Not assigned SDC_TXDMARQ: Writing SD data 011: SDC_RXDMARQ: Reading SD data SDC_TXDMARQ: Not assigned 010: SDC_RXDMARQ: Not assigned SDC_TXDMARQ: Not assigned 001: SDC_RXDMARQ: Reading SD data SDC_TXDMARQ: Writing SD data 000: SDC_RXDMARQ: Reading SD data SDC_TXDMARQ: Writing SD data
Reserved	R	1	0	Reserved. If this bit is read, 0 is returned.

(2/2)

Name	R/W	Bit No.	After Reset	Description
CD	R/W	0	0	Resets the SDC bus wrapper and DMA interrupt control blocks by using software. 0: Cancel the reset state. 1: Reset the blocks. Caution SDC_SOFT_RST has inverted logic.

Note Using of external loop

Output of SD_CKO is wired from EMEV to a SD card and it's connected to a SD card.

A loop back to EMEV, and input that to SD_CKI.

When SD_CKO and SD_CKI are connected simply, an AC specification can't sometimes be satisfied..

3.2.30 SDC user register 2

This register (SDC_USER2: 0204H) specifies the internal SD clock group delay and the synchronization mode.

15	14	13	12	11	10	9	8
Reserved					IntParam2	IntParam1	IntParam0
7	6	5	4	3	2	1	0
Reserved							SYNCMODE

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:11	00H	Reserved. If these bits are read, 0 is returned for each bit.
IntParam[2:0]	R/W	10:8	0H	Internal adjustment bit Do not specify a value other than 000b.
Reserved	R	7:1	00H	Reserved. If these bits are read, 0 is returned for each bit.
SYNCMODE	R/W	0	0	Specify the synchronization mode. 0: Asynchronous mode 1: Synchronous mode

The signal that results from logically combining (ORing) bit 15 of the SDC use register (SDC_USER) and bit 0 of SDC use register 2 (SDC_USER2) is the synchronization signal to be used to control the circuits.

	Bit 15 of SDC_USER	Bit 0 of SDC_USER2	Mode Control Signal Level	Mode
Pattern 1	0	0	0	Asynchronous mode
Pattern 2	0	1	1	Synchronous mode
Pattern 3	1	0	1	Synchronous mode
Pattern 4	1	1	1	Synchronous mode

3.2.31 Module reset control register

This register (SDC_RST_CTRL_CTRL: 0210H)

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved	Reserved	Reserved	Reserved	Reserved	F0RST	MHRST	AMRST

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:6	000H	Reserved. If these bits are read, 0 is returned for each bit.
Reserved	R	5	0	Reserved. If this bit is read, 0 is returned. Writing in of "1" is prohibited.
Reserved	R	4	0	Reserved. If this bit is read, 0 is returned. Writing in of "1" is prohibited.
Reserved	R	3	0	Reserved. If this bit is read, 0 is returned. Writing in of "1" is prohibited.
F0RST	R/W	2	0	FIFO0 (SD R/W) control module reset 0 : Reset release 1 : Reset
MHRST	R/W	1	0	HOST control module reset 0 : Reset release 1 : Reset
AMRST	R/W	0	0	AHB master control module reset 0 : Reset release 1 : Reset

3.2.32 AHB bus interface control register

This register (SDC_BUSIF_CTRL: 0214H)

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved		ACCTYPE	ERR_MASTER		BURSTMODE		AMCEN

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:6	000H	Reserved. If these bits are read, 0 is returned for each bit.
ACCTYPE	R/W	5	0	Select the core access address type (This function not used) 0: Register setting 1: Value fixed (0x7F)
ERR_MASTER	R	4:3	00b	AHB error occurrence master ID 00b: SD R/W transfer 01b: C2 input transfer 10b: C2 output transfer
BURSTMODE	R/W	2:1	00b	Select the AHB master/burst transfer mode 00b: Single 01b: INCR4 10b: INCR8 11b: INCR16
AMCEN	R/W	0	0	Specify the AHB master transfer. 0: Invalid 1: Valid

3.2.33 DMA mask setting register

This register (SDC_DMAMSK_CTRL: 021CH)

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved				DMAMSK_CC	DMAMSK_CC	DMAMSK_SD	DMAMSK_SD
				W	R	W	R

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:4	000H	Reserved. If these bits are read, 0 is returned for each bit.
DMAMSK_CCW	R/W	3	1	Specify the mask control of C2 write transfer DMA. 0: Valid 1: Mask
DMAMSK_CCR	R/W	2	1	Specify the mask control of C2 read transfer DMA. 0: Valid 1: Mask
DMAMSK_SDW	R/W	1	1	Specify the mask control of SD write transfer DMA. 0: Valid 1: Mask
DMAMSK_SDR	R/W	0	1	Specify the mask control of SD read transfer DMA. 0: Valid 1: Mask

3.2.34 SD write transfer data storage address

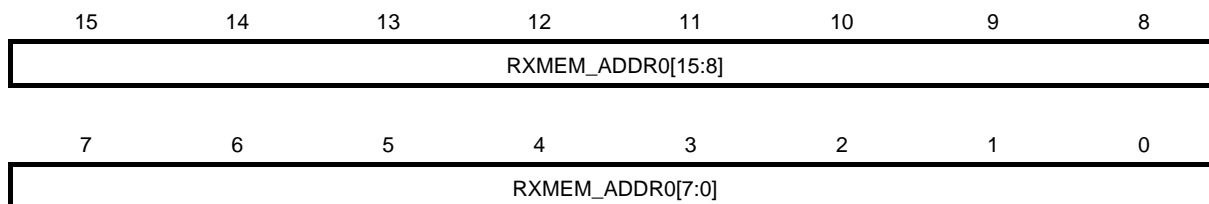
This register (SDC_TXMEM_ADDR0L: 0220H)

15	14	13	12	11	10	9	8
TXMEM_ADDR0[15:8]							
7	6	5	4	3	2	1	0
TXMEM_ADDR0[7:0]							

Name	R/W	Bit No.	After Reset	Description
TXMEM_ADDR0	R/W	15:0	0000H	The start address (lower 16bit) when reading data from a memory, is established at the time of writing in on a SD card.

3.2.35 SD read transfer data storage address

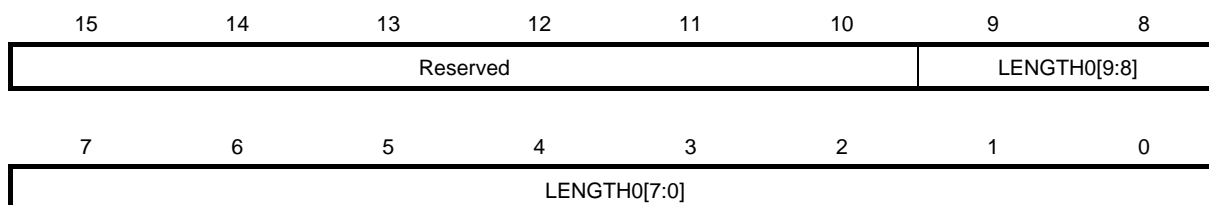
This register (SDC_RXMEM_ADDR0L: 0228H)



Name	R/W	Bit No.	After Reset	Description
RXMEM_ADDR0	R/W	15:0	0000H	The start address (lower 16bit) when writing data from a memory, is established at the time of reading in on a SD card.

3.2.36 SD sector length setting register

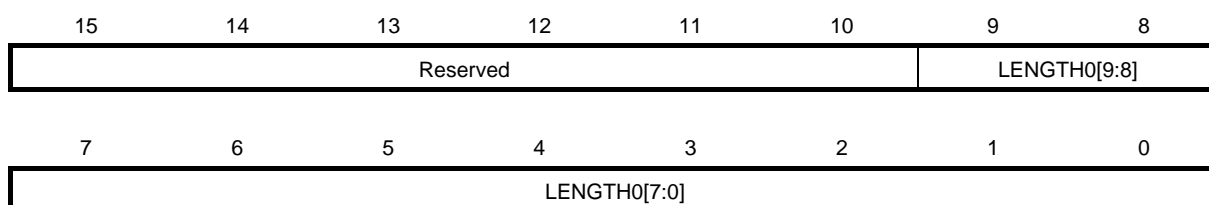
This register (SDC_SECTOR_LENGTH0: 0230H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:10	00H	Reserved. If these bits are read, 0 is returned for each bit.
LENGTH0	R/W	9:0	000H	The sector length which is at the time of DMA transmission is set.

3.2.37 SD block length setting register

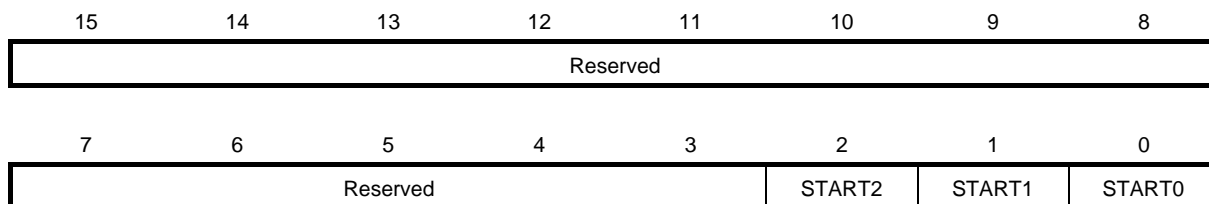
This register (SDC_BLOCK_LENGTH0: 0240H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:10	00H	Reserved. If these bits are read, 0 is returned for each bit.
LENGTH0	R/W	9:0	000H	The block length which is at the time of DMA transmission is set.

3.2.38 DMA startup register

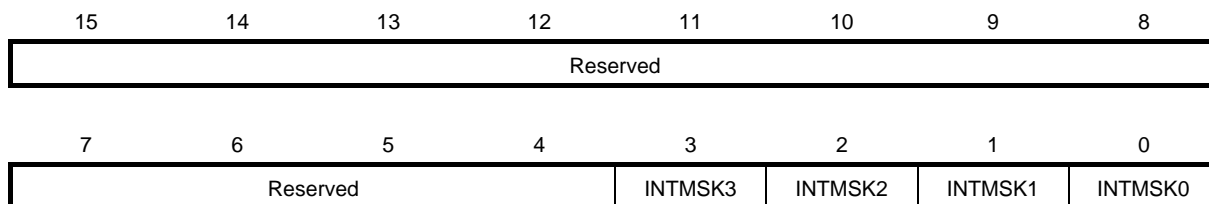
This register (SDC_TRANS_START: 0260H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:3	0000H	Reserved. If these bits are read, 0 is returned for each bit.
START2	R/W	2	0	Specify the C2 write DMA startup. 0: Stop 1: Start
START1	R/W	1	0	Specify the C2 Read DMA startup. 0: Stop 1: Start
START0	R/W	0	0	Specify the SD R/W DMA startup. 0: Stop 1: Start

3.2.39 Interrupt mask register

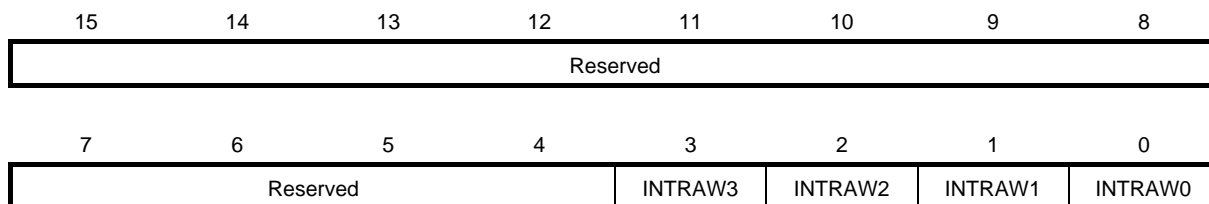
This register (SDC_INT_MSK: 0270H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:4	000H	Reserved. If these bits are read, 0 is returned for each bit.
INTMSK3	R/W	3	1	Specify the error occurrence interrupt mask. 0: No mask 1: Mask
INTMSK2	R/W	2	1	Specify the C2 writing in completion interrupt mask. 0: No mask 1: Mask
INTMSK1	R/W	1	1	Specify the C2 reading in completion interrupt mask. 0: No mask 1: Mask
INTMSK0	R/W	0	1	Specify the SD R/W in completion interrupt mask. 0: No mask 1: Mask

3.2.40 Interrupt factor RAW register

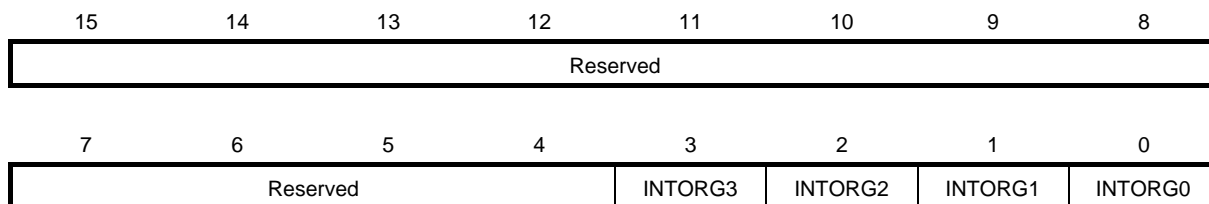
This register (SDC_INT_RAW: 0274H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:4	000H	Reserved. If these bits are read, 0 is returned for each bit.
INTRAW3	R/W	3	1	Specify the error occurrence interrupt RAW factor. 0: No mask 1: Mask
INTRAW2	R/W	2	1	Specify the C2 writing in completion interrupt RAW factor. 0: No mask 1: Mask
INTRAW1	R/W	1	1	Specify the C2 reading in completion interrupt RAW factor. 0: No mask 1: Mask
INTRAW0	R/W	0	1	Specify the SD R/W in completion interrupt RAW factor. 0: No mask 1: Mask

3.2.41 Interrupt factor register

This register (SDC_INT_ORG: 0278H)



Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:4	000H	Reserved. If these bits are read, 0 is returned for each bit.
INTORG3	R/W	3	1	Specify the error occurrence interrupt factor. 0: No mask 1: Mask
INTORG2	R/W	2	1	Specify the C2 writing in completion interrupt factor. 0: No mask 1: Mask
INTORG1	R/W	1	1	Specify the C2 reading in completion interrupt factor. 0: No mask 1: Mask
INTORG0	R/W	0	1	Specify the SD R/W in completion interrupt factor. 0: No mask 1: Mask

3.2.42 Interrupt factor clear register

This register (SDC_INT_CLR: 027CH)

15	14	13	12	11	10	9	8
Reserved							
7	6	5	4	3	2	1	0
Reserved				INTCLR3	INTCLR2	INTCLR1	INTCLR0

Name	R/W	Bit No.	After Reset	Description
Reserved	R	15:4	000H	Reserved. If these bits are read, 0 is returned for each bit.
INTCLR3	R/W	3	1	Specify the error occurrence interrupt factor clear. 0: No mask 1: Mask
INTCLR2	R/W	2	1	Specify the C2 writing in completion interrupt factor clear. 0: No mask 1: Mask
INTCLR1	R/W	1	1	Specify the C2 reading in completion interrupt factor clear. 0: No mask 1: Mask
INTCLR0	R/W	0	1	Specify the SD R/W in completion interrupt factor clear. 0: No mask 1: Mask

3.2.43 SD write transfer data storage address

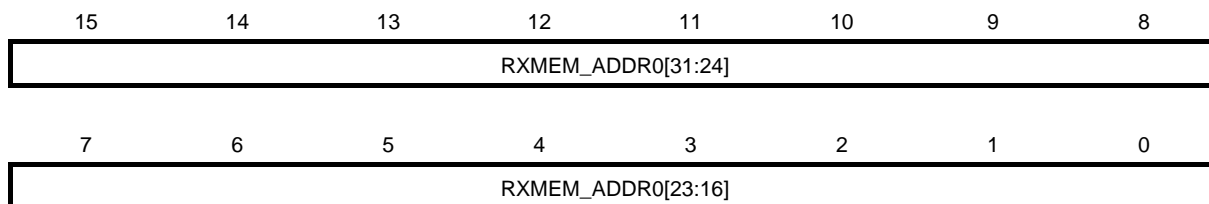
This register (SDC_TXMEM_ADDR0H: 0290H)

15	14	13	12	11	10	9	8
TXMEM_ADDR0[31:24]							
7	6	5	4	3	2	1	0
TXMEM_ADDR0[23:16]							

Name	R/W	Bit No.	After Reset	Description
TXMEM_ADDR0	R/W	15:0	0000H	The start address (upper 16bit) when reading data from a memory, is established at the time of writing in on a SD card.

3.2.44 SD read transfer data storage address

This register (SDC_RXMEM_ADDR0H: 0298H)

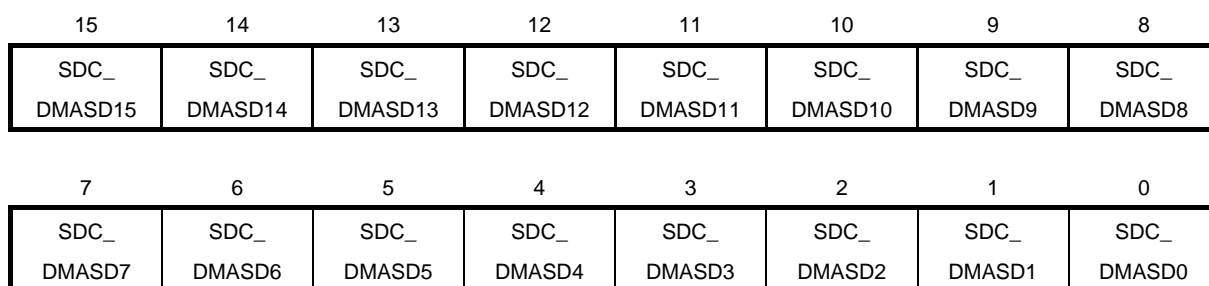


Name	R/W	Bit No.	After Reset	Description
RXMEM_ADDR0	R/W	15:0	0000H	The start address (upper 16bit) when writing data from a memory, is established at the time of reading in on a SD card.

3.2.45 DMA mode SD buffer register

This buffer register (SDC_DMASD: 0300H) is used to read or write the SD registers when the SDC module runs in DMA mode.

Remark If the DMA controller accesses the SDC SD read/write buffer: SDC_DMASD
 If the CPU accesses the SDC SD read/write buffer: SDC_BUF0



Name	R/W	Bit No.	After Reset	Description
SDC_DMASD[15:0]	R/W	15:0	0000H	SD buffer used during a DMA transfer

4. Description of Functions

4.1 SD Card Data Format

Figures 4-1 and 4-2 show the timing for transferring data in 1-bit transfer mode and in 4-bit transfer mode, respectively. In 1-bit transfer mode, SDC_DATA0 is used as the data line.

Figure 4-1. SD Card Data Format (in 1-bit Transfer Mode)

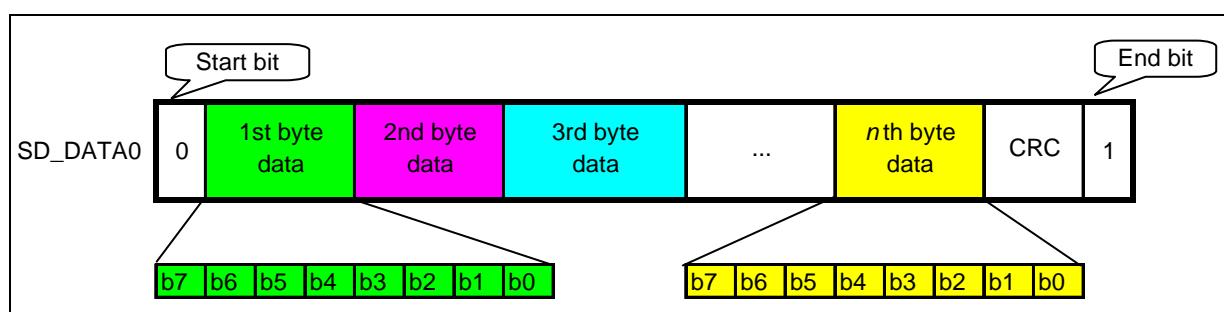
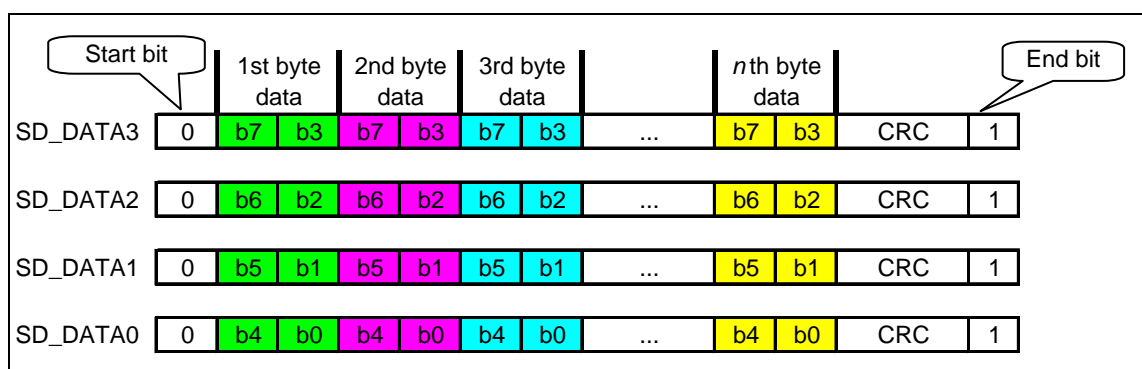


Figure 4-2. SD Card Data Format (in 4-bit Transfer Mode)



4.2 SDIO Interrupts

The SDC module supports SDIO interrupts that conform to SDIO Card Specification Ver. 1.0.

According to this specification, interrupts from an SDIO card are generated using bit 1 of the SD data line, but an SDIO card can only be detected in either of the following periods:

<1> In an asynchronous interrupt period: The SD data line is used as an interrupt line when data transfer that uses bit 1 of the SD data line is not taking place.

<2> In a synchronous interrupt period: Interrupts are output only at a certain timing when multiple blocks are transferred if the SD data line is in 4-bit mode.

The following figures show the interrupt periods when the SDC module is used with the SD data line in 1-bit mode and in 4-bit mode (for single block transfers and multiple block transfers).

The SDC module is allocated to the L1 domain. Because the power is not necessarily supplied to the L1 domain when the SDC module starts, SD_DATA1 is connected to CHG, which is allocated to the L0 domain (where the power is always on), interrupts are disabled in CHG, and a register that stores interrupt sources is implemented in CHG. Startup interrupts from the SDIO device are handled by CHG using an SDC startup interrupt feature. To enable this operation, after the SDC module starts, disable the SDC startup interrupt by using a CHG register, and then enable the SDC asynchronous interrupts to perform normal operations.

Figure 4-3 shows the overview of the SDC startup sequence when an SDIO card is detected.

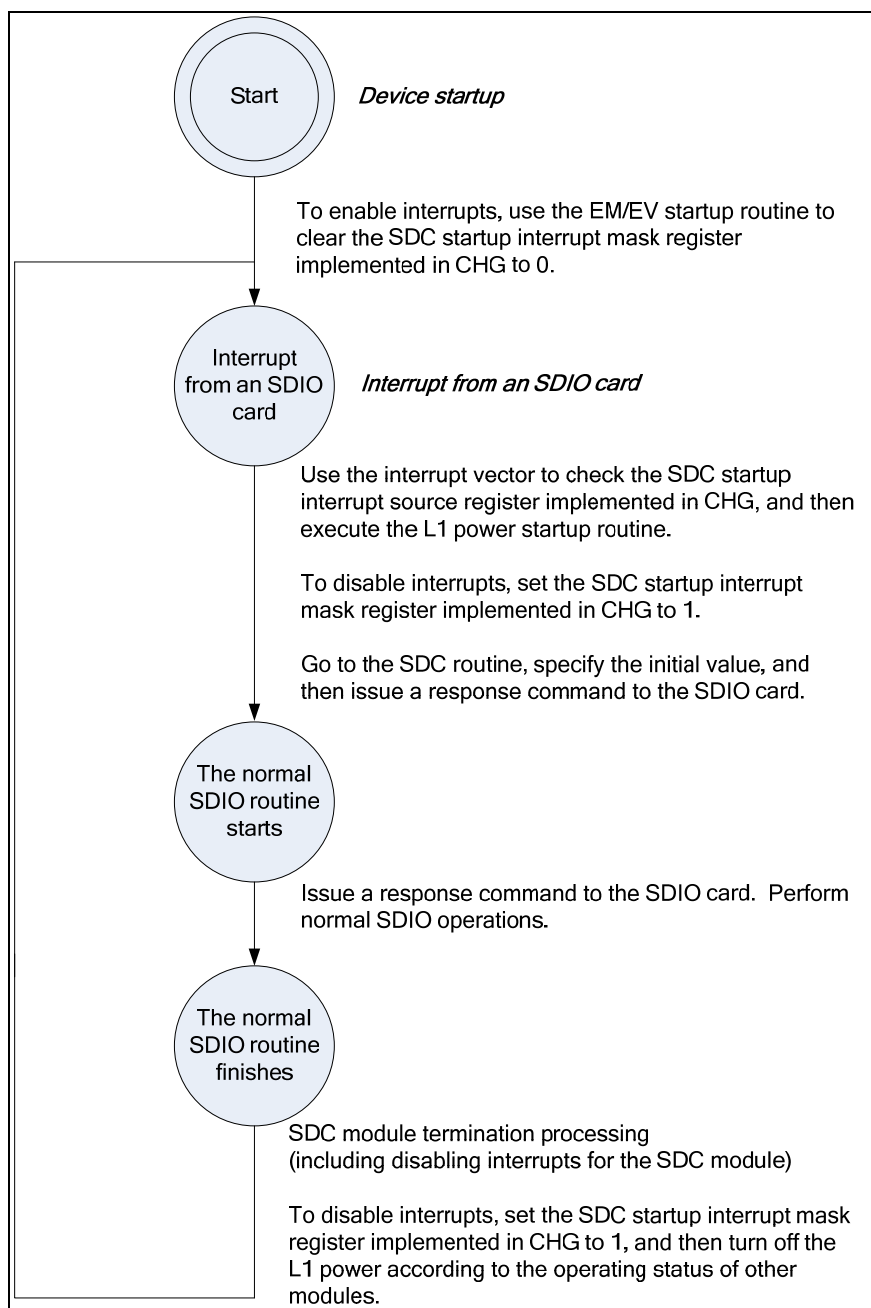
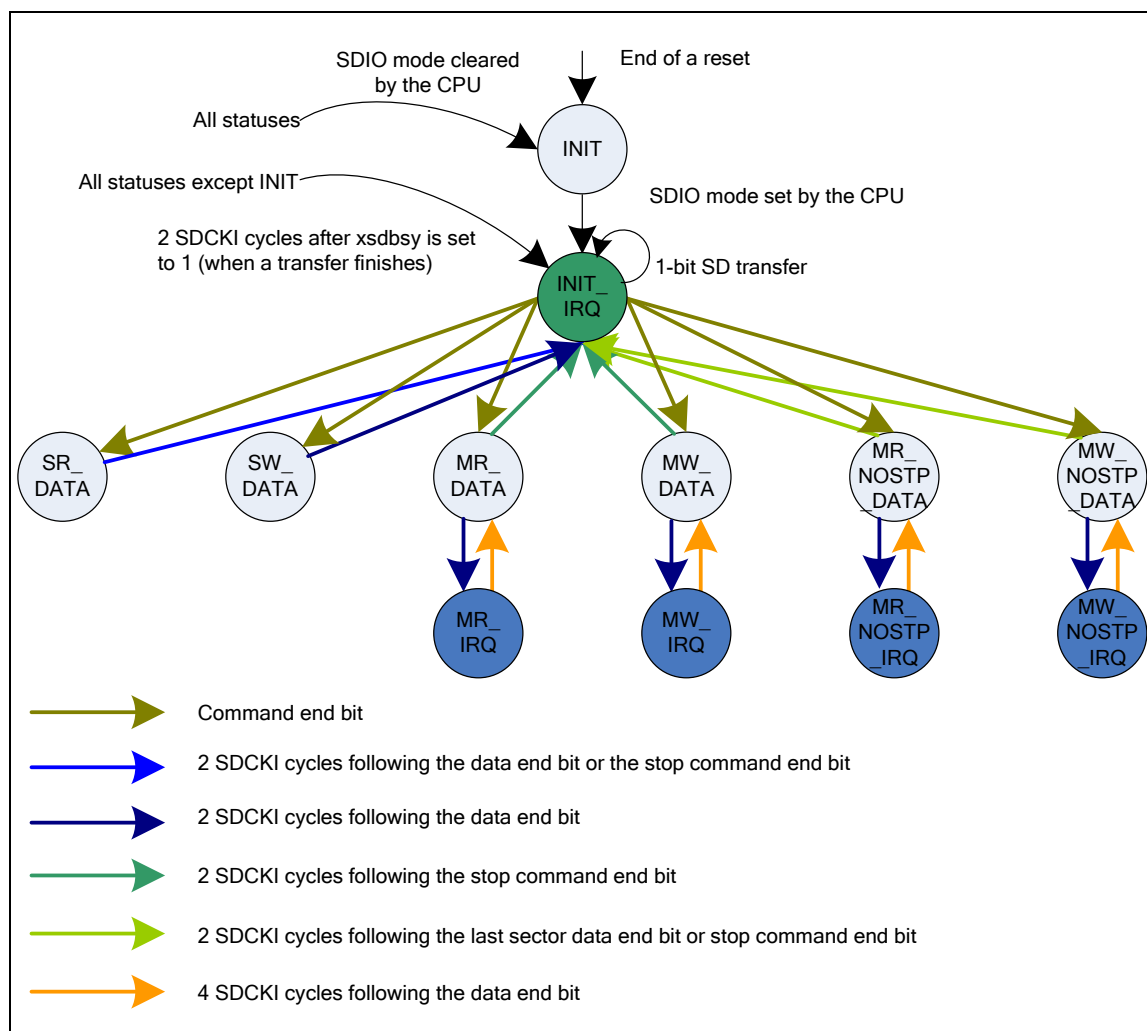
Figure 4-3. SDC Startup Sequence Triggered by SDIO Card Detection

Figure 4-4 shows the status transitions.

In this figure, INIT_IRQ shows the asynchronous interrupt period, MR_IRQ, MW_IRQ, MR_NOSTP_IRQ, and MW_NOSTP_IRQ show the synchronous interrupt period, and other items show the interrupt-disabled period.

Figure 4-4. SDC SDIO Interrupt Status Transitions



Remark	SR_DATA:	Single-block data read transaction
	SW_DATA:	Single-block data write transaction
	MR_DATA:	Multi-block data read transaction (not affected by a stop command)
	MW_DATA:	Multi-block data write transaction (not affected by a stop command)
	MR_NOSTP_DATA:	Multi-block data read transaction
	MW_NOSTP_DATA:	Multi-block data write transaction
	MR_IRQ:	Multi-block read interrupt timing (not affected by a stop command)
	MW_IRQ:	Multi-block write interrupt timing (not affected by a stop command)
	MR_NOSTP_IRQ:	Multi-block read interrupt timing
	MW_NOSTP_IRQ:	Multi-block write interrupt timing

REVISION HISTORY	EMMA Mobile EV2 User's Manual: SD Card Interface
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Rev.	Date	Description	
		Page	Summary
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2.00	Jun 7, 2010	—	Incremental update from comments to the 1.0.
3.00	Apr 15, 2011	—	3.2.31 - 3.2.43 register added. Incremental update from comments to the 2.0. (A change part from the old revision is “★” marked in the page left end.)
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5.00	Dec 21, 2011	31	Chapter 3.2.31 added.

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SD Card Interface

EMMA Mobile EV2



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